SDAS153E - DECEMBER 1982 - REVISED AUGUST 1995

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

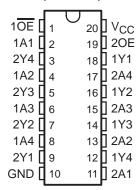
description

These octal buffers/drivers are designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable (\overline{OE}) inputs, and complementary OE and \overline{OE} inputs. These devices feature high fan-out and improved fan-in.

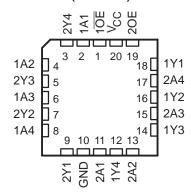
The -1 version of SN74ALS241C is identical to the standard version, except that the recommended maximum I_{OL} of the -1 version is 48 mA. There is no -1 version of the SN54ALS241C.

The SN54ALS241C and SN54AS241A are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS241C and SN74AS241A are characterized for operation from 0°C to 70°C.

SN54ALS241C, SN54AS241A . . . J PACKAGE SN74ALS241C, SN74AS241A . . . DW OR N PACKAGE (TOP VIEW)



SN54ALS241C, SN54AS241A . . . FK PACKAGE (TOP VIEW)



FUNCTION TABLES

INPU	JTS	OUTPUT
10E	1A	1Y
L	Н	Н
L	L	L
Н	Χ	Z

INP	JTS	OUTPUT
20E	2A	2Y
Н	Н	Н
Н	L	L
L	Χ	Z

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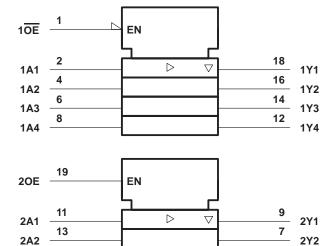
logic symbol†

15

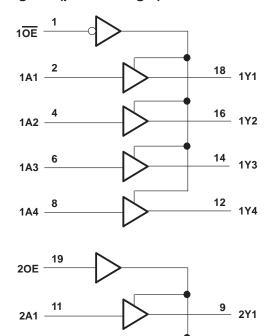
17

2A3

2A4



logic diagram (positive logic)



7 ___ 2Y2

5 2Y3

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

5

3

2Y3

2Y4

Supply voltage, V _{CC}	7 V
Input voltage, V _I	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T _A : SN54ALS241C	55°C to 125°C
SN74ALS241C	0°C to 70°C
Storage temperature range	65°C to 150°C

2A2

2A3

 $[\]dagger$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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recommended operating conditions

		SNS	4ALS24	1C	SN7	'4ALS24	1C	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.7			8.0	V
lOH	High-level output current			-12			-15	mA
	Level and autorit compart			12			24	4
lOL	Low-level output current						48†	mA
TA	Operating free-air temperature	-55		125	0		70	°C

[†] Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

24244555		CONDITIONS	SN	54ALS24	1C	SN7	74ALS24	1C	LINUT	
PARAMETER	TEST	TEST CONDITIONS			MAX	MIN	TYP [‡]	MAX	UNIT	
VIK	V _{CC} = 4.5 V,	I _I = –18 mA			-1.2			-1.2	V	
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2			
V		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V	
Voн	V _{CC} = 4.5 V	I _{OH} = -12 mA	2						V	
		I _{OH} = -15 mA				2				
		I _{OL} = 12 mA		0.25	0.4		0.25	0.4		
V _{OL}	V _{CC} = 4.5 V	I _{OL} = 24 mA					0.35	0.5	V	
		I _{OL} = 48 mA (-1 version)					0.35	0.5		
IOZH	V _{CC} = 5.5 V,	V _O = 2.7 V			20			20	μΑ	
I _{OZL}	V _{CC} = 5.5 V,	V _O = 0.4 V			-20			-20	μΑ	
lį	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA	
lН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ	
I _{IL}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA	
ΙΟ§	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA	
		Outputs high		9	17		9	18		
ICC	V _{CC} = 5.5 V	Outputs low		15	28		15	26	mA	
		Outputs disabled		17	32		17	30		

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

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switching characteristics (see Figure 1)

PARAMETER	PARAMETER FROM TO (OUTPUT)		C _I R1 R2 T _A	= 50 pl l = 500 Ω 2 = 500 Ω _ = MIN t	2, 2, 10 MAX†		UNIT
			SN54AL	S241C	SN74AL	S241C	
			MIN	MAX	MIN	MAX	
t _{PLH}	Λ.	Υ	3	31	2	11	20
^t PHL	А	Y	1	17	3	10	ns
^t PZH	1 0E	Υ	3	33	3	21	
t _{PZL}	10E	Y	3	27	4	21	ns
^t PHZ	405	V	2	17	1	10	
^t PLZ	1 <mark>OE</mark>	Y	2	32	2	15	ns
^t PZH	205	.,	3	38	4	21	
t _{PZL}	20E	Y	3	30	5	21	ns
^t PHZ	20E	Υ	2	17	2	10	no
^t PLZ	ZUE	f	3	35	3	15	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	7 V
Input voltage, V _I	$\dots \dots $
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T _A : SN54AS241A	-55°C to 125°C
SN74AS241A	0°C to 70°C
Storage temperature range	-65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS241A			SN	LINUT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
ІОН	High-level output current			-12			-15	mA
l _{OL}	Low-level output current			48			64	mA
TA	Operating free-air temperature	-55		125	0		70	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			SN	54AS24	1A	SN	74AS24	IA	
PARAMETER	TEST C	TEST CONDITIONS			MAX	MIN	TYP†	MAX	UNIT
VIK	$V_{CC} = 4.5 V,$	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2	2		VCC -2)		
Varia		IOH = -3 mA	2.4	3.4		2.4	3.4		
VOH	V _{CC} = 4.5 V	I _{OH} = -12 mA	2.4						V
		$I_{OH} = -15 \text{ mA}$				2.4			
· ,,	V 45V	I _{OL} = 48 mA		0.27	0.55				.,
V _{OL}	V _{CC} = 4.5 V	I _{OL} = 64 mA					0.31	0.55	V
lozh	$V_{CC} = 5.5 \text{ V},$	V _O = 2.7 V			50			50	μΑ
lozL	$V_{CC} = 5.5 V$,	V _O = 0.4 V			-50			-50	μΑ
lį	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
lН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ
IIL	V _{CC} = 5.5 V,	V _I = 0.4 V			-1			-1	mA
IO [‡]	V _{CC} = 5.5 V,	V _O = 2.25 V	-50		-150	-50		-150	mA
		Outputs high		22	35		22	35	
ICC	V _{CC} = 5.5 V	Outputs low		61	90		61	90	mA
		Outputs disabled		35	56		35	56	

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	F F	EL = 50 R1 = 500 R2 = 500 A = MIN	Ω , Ω , to MAX	§	UNIT
			SN54A	S241A	SN74A	S241A	
			MIN	MAX	MIN	MAX	
t _{PLH}	A	V	2	9	2	6.2	
t _{PHL}	А	Υ	1	7	1	6.2	ns
^t PZH	105	V	1	10	1	9	
t _{PZL}	1 <mark>0E</mark>	Y	2	8	2	7.5	ns
t _{PHZ}	405	V	1	6.5	1	6	
^t PLZ	1 <mark>0E</mark>	Y	1	10.5	1	9	ns
^t PZH	205	.,	2	11	2	10.5	
t _{PZL}	20E	Υ	3	9.5	3	8.5	ns
^t PHZ	20E	Υ	1	7	1	7	200
^t PLZ	ZUE	ı	2	12	2	12	ns

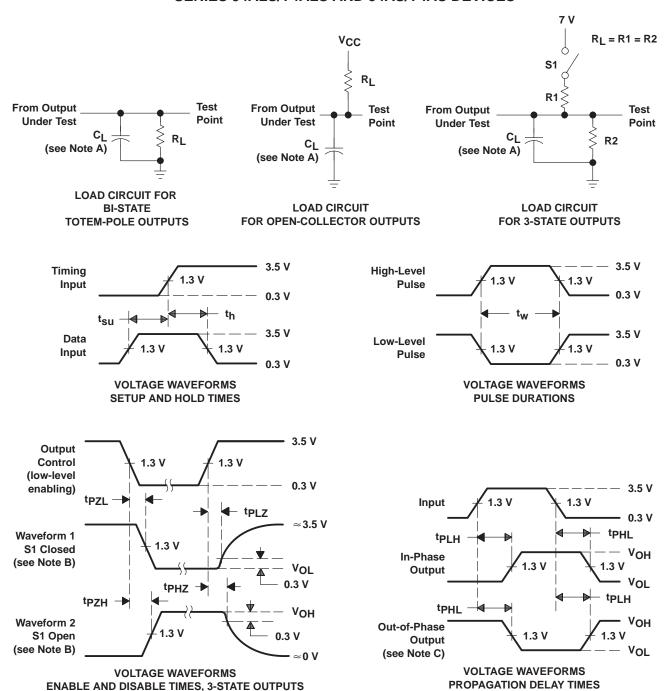
[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
JM38510/38302BRA	Active	Production	CDIP (J) 20	20 TUBE	No	(4) SNPB	N/A for Pkg Type	-	JM38510/ 38302BRA
JM38510/38302BRA.A	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 38302BRA
M38510/38302BRA	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 38302BRA
SN54ALS241CJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54ALS241CJ
SN54ALS241CJ.A	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54ALS241CJ
SN54AS241AJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54AS241AJ
SN54AS241AJ.A	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54AS241AJ
SN74ALS241CDW	Obsolete	Production	SOIC (DW) 20	-	-	Call TI	Call TI	0 to 70	ALS241C
SN74ALS241CDWR	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS241C
SN74ALS241CDWR.A	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS241C
SN74ALS241CN	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS241CN
SN74ALS241CN.A	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS241CN
SN74AS241AN	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS241AN
SN74AS241AN.A	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS241AN
SNJ54ALS241CFK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54 ALS241CFK
SNJ54ALS241CFK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54 ALS241CFK
SNJ54ALS241CJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54ALS241CJ
SNJ54ALS241CJ.A	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54ALS241CJ
SNJ54AS241AJ	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54AS241AJ
SNJ54AS241AJ.A	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54AS241AJ

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

PACKAGE OPTION ADDENDUM

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- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF SN54ALS241C, SN54AS241A, SN74ALS241C, SN74AS241A:

Catalog: SN74ALS241C, SN74AS241A

Military: SN54ALS241C, SN54AS241A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS241CDWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

ſ	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
I	SN74ALS241CDWR	SOIC	DW	20	2000	356.0	356.0	45.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74ALS241CN	N	PDIP	20	20	506	13.97	11230	4.32
SN74ALS241CN.A	N	PDIP	20	20	506	13.97	11230	4.32
SN74AS241AN	N	PDIP	20	20	506	13.97	11230	4.32
SN74AS241AN.A	N	PDIP	20	20	506	13.97	11230	4.32
SNJ54ALS241CFK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54ALS241CFK.A	FK	LCCC	20	55	506.98	12.06	2030	NA

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



INSTRUMENTS www.ti.com

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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